ANALOG DEVICES

## FEATURES

Fast throughput rate: 3 MSPS
Wide input bandwidth: 40 MHz
No pipeline delays with SAR ADC
Excellent DC accuracy performance
Two parallel interface modes
Low power: 90 mW (full power) and 2.5 mW (NAP mode)
Standby mode: $2 \mu \mathrm{~A}$ max
Single 5 V supply operation
Internal 2.5 V reference
Full-scale overrange mode (using 15th bit)
System offset removal via user access offset register
Nominal 0 V to 2.5 V input with shifted range capability Pin compatible upgrade of 12-Bit AD7482

## GENERAL DESCRIPTION

The AD7484 is a 14-bit, high speed, low power, successive approximation ADC. The part features a parallel interface with throughput rates up to 3 MSPS. The part contains a low noise, wide bandwidth track-and-hold that can handle input frequencies in excess of 40 MHz .

The conversion process is a proprietary algorithmic successive approximation technique that results in no pipeline delays. The input signal is sampled and a conversion is initiated on the falling edge of the CONVST signal. The conversion process is controlled via an internally trimmed oscillator. Interfacing is via standard parallel signal lines, making the part directly compatible with microcontrollers and DSPs.

The AD7484 provides excellent ac and dc performance specifications. Factory trimming ensures high dc accuracy resulting in very low INL, offset, and gain errors.

The part uses advanced design techniques to achieve very low power dissipation at high throughput rates. Power consumption in the normal mode of operation is 90 mW . There are two

## Rev. A

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## FUNCTIONAL BLOCK DIAGRAM



Figure 1.
power saving modes: NAP mode, which keeps the reference circuitry alive for a quick power-up while consuming 2.5 mW , and standby mode, which reduces power consumption to a mere $10 \mu \mathrm{~W}$.

The AD7484 features an on-board 2.5 V reference but can also accommodate an externally provided 2.5 V reference source. The nominal analog input range is 0 V to 2.5 V , but an offset shift capability allows this nominal range to be offset by $\pm 200 \mathrm{mV}$. This allows the user considerable flexibility in setting the bottom end reference point of the signal range, a useful feature when using single-supply op amps.

The AD7484 also provides the user with an 8\% overrange capability via a 15 th bit. Therefore, if the analog input range strays outside the nominal range by up to $8 \%$, the user can still accurately resolve the signal by using the 15th bit.

The AD7484 is powered by a 4.75 V to 5.25 V supply. The part also provides a $V_{\text {drive }}$ pin that allows the user to set the voltage levels for the digital interface lines. The range for this $\mathrm{V}_{\text {drive }} \mathrm{pin}$ is from 2.7 V to 5.25 V . The part is housed in a 48 -lead LQFP package and is specified over a $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ temperature range.

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## SPECIFICATIONS

$\mathrm{V}_{\mathrm{DD}}=5 \mathrm{~V} \pm 5 \%, \mathrm{AGND}=\mathrm{DGND}=0 \mathrm{~V}, \mathrm{~V}_{\text {ReF }}=$ External, $\mathrm{f}_{\text {SAMPLE }}=3 \mathrm{MSPS}$; all specifications $\mathrm{T}_{\text {MIN }}$ to $\mathrm{T}_{\text {MAX }}$ and valid for $\mathrm{V}_{\text {DRIVE }}=2.7 \mathrm{~V}$ to 5.25 V , unless otherwise noted. Table 1 temperature range is: $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$.

Table 1.

| Parameter | Specification | Unit | Test Conditions/Comments |
| :---: | :---: | :---: | :---: |
| DYNAMIC PERFORMANCE ${ }^{1,2}$ |  |  |  |
| Signal-to-Noise + Distortion (SINAD) ${ }^{3}$ | 76.5 | dB min | $\mathrm{F}_{\text {IN }}=1 \mathrm{MHz}$ |
|  | 78 | dB typ | $\mathrm{F}_{\text {IN }}=1 \mathrm{MHz}$ |
|  | 79 | dB typ | $\mathrm{F}_{\text {IN }}=1 \mathrm{MHz}$, Extended Input |
|  | 77 | dB typ | Fin $=1 \mathrm{MHz}$, Internal Reference |
| Total Harmonic Distortion (THD) ${ }^{3}$ | -90 | dB max |  |
|  | -95 | dB typ |  |
|  | -92 | dB typ | Internal Reference |
| Peak Harmonic or Spurious Noise (SFDR) ${ }^{3}$ | -90 | dB max |  |
| Intermodulation Distortion (IMD) ${ }^{3}$ |  |  |  |
| Second-Order Terms | -96 | dB typ | $\mathrm{F}_{\mathrm{IN} 1}=95.053 \mathrm{kHz}, \mathrm{F}_{\mathrm{N} 2}=105.329 \mathrm{kHz}$ |
| Third-Order Terms | -94 | dB typ |  |
| Aperture Delay | 10 | ns typ |  |
| Full-Power Bandwidth | 40 | MHz typ | @ 3 dB |
|  | 3.5 | MHz typ | @ 0.1 dB |
| DC ACCURACY |  |  |  |
| Resolution | 14 | Bits |  |
| Integral Nonlinearity ${ }^{3}$ | $\pm 1$ | LSB max |  |
|  | $\pm 0.5$ | LSB typ |  |
| Differential Nonlinearity ${ }^{3}$ | $\pm 0.75$ | LSB max | Guaranteed No Missed Codes to 14 Bits |
|  | $\pm 0.3$ | LSB typ |  |
| Offset Error ${ }^{3}$ | $\pm 6$ | LSB max |  |
|  | 0.036 | \%FSR max |  |
| Gain Error ${ }^{3}$ | $\pm 6$ | LSB max |  |
|  | 0.036 | \%FSR max |  |
| ANALOG INPUT |  |  |  |
| Input Voltage | -200 | mV min |  |
|  | +2.7 | $\checkmark$ max |  |
| DC Leakage Current | $\pm 1$ | $\mu \mathrm{A}$ max | V IN from 0 V to 2.7 V |
|  | $\pm 2$ | $\mu \mathrm{A}$ typ | $\mathrm{V}_{\mathrm{IN}}=-200 \mathrm{mV}$ |
| Input Capacitance ${ }^{4}$ | 35 | pF typ |  |
| REFERENCE INPUT/OUTPUT |  |  |  |
| $V_{\text {Refin }}$ Input Voltage | +2.5 | V | $\pm 1 \%$ for Specified Performance |
| $V_{\text {REFIN }}$ Input DC Leakage Current | $\pm 1$ | $\mu \mathrm{A}$ max |  |
| $\mathrm{V}_{\text {ReFII }}$ Input Capacitance ${ }^{4}$ | 25 | pF typ |  |
| $V_{\text {Refin }}$ Input Current | 220 | $\mu \mathrm{A}$ typ | External Reference |
| $\mathrm{V}_{\text {Refout }}$ Output Voltage | +2.5 | V typ |  |
| $V_{\text {Refout }}$ Error @ $25^{\circ} \mathrm{C}$ | $\pm 50$ | mV typ |  |
| $V_{\text {refout }}$ Error $\mathrm{Tmin}^{\text {to }}$ Tmax | $\pm 100$ | $m \mathrm{Vmax}$ |  |
| $\mathrm{V}_{\text {REFOut }}$ Output Impedance | 1 | $\Omega$ typ |  |
| LOGIC INPUTS |  |  |  |
| Input High Voltage, $\mathrm{V}_{\text {INH }}$ | $\mathrm{V}_{\text {drive }}-1$ | $\checkmark$ min |  |
| Input Low Voltage, VINL | 0.4 | $V$ max |  |
| Input Current, lin | $\pm 1$ | $\mu \mathrm{A}$ max |  |
| Input Capacitance, $\mathrm{ClN}^{4}$ | 10 | pF max |  |

## AD7484

| Parameter | Specification | Unit | Test Conditions/Comments |
| :---: | :---: | :---: | :---: |
| LOGIC OUTPUTS <br> Output High Voltage, V <br> Output Low Voltage, Vo <br> Floating-State Leakage Current Floating-State Output Capacitance ${ }^{4}$ Output Coding | $\begin{aligned} & 0.7 \times V_{\text {DRIVE }} \\ & 0.3 \times V_{\text {DRIVE }} \\ & \pm 10 \\ & 10 \\ & \text { Straight (Natur } \end{aligned}$ | $\vee$ min <br> $V$ max <br> $\mu \mathrm{A}$ max <br> pF max <br> nary |  |
| CONVERSION RATE <br> Conversion Time <br> Track-and-Hold Acquisition Time ( $\mathrm{t}_{\mathrm{ACO}}$ ) <br> Throughput Rate | $\begin{aligned} & 300 \\ & 70 \\ & 70 \\ & 2.5 \\ & 3 \end{aligned}$ | ns max <br> ns max <br> ns max <br> MSPS max <br> MSPS max | Sine Wave Input <br> Full-Scale Step Input <br> Parallel Mode 1 <br> Parallel Mode 2 |
| POWER REQUIREMENTS $\begin{aligned} & V_{D D} \\ & V_{\text {DRIVE }} \end{aligned}$ | $\begin{aligned} & 5 \\ & 2.7 \\ & 5.25 \end{aligned}$ | $\vee$ min <br> V max | $\pm 5 \%$ |
| IDD <br> Normal Mode (Static) <br> Normal Mode (Operational) <br> NAP Mode <br> Standby Mode | $\begin{aligned} & 12 \\ & 18 \\ & 0.5 \\ & 2 \\ & 0.5 \end{aligned}$ | mA max mA max mA max $\mu \mathrm{A}$ max $\mu \mathrm{A}$ typ | $\overline{\mathrm{CS}} \text { and } \overline{\mathrm{RD}}=\text { Logic } 1$ |
| Power Dissipation <br> Normal Mode (Operational) <br> NAP Mode <br> Standby Mode ${ }^{5}$ | $\begin{aligned} & 90 \\ & 2.5 \\ & 10 \end{aligned}$ | mW max mW max $\mu \mathrm{W}$ max |  |

[^1]
## TIMING CHARACTERISTICS

$\mathrm{V}_{\mathrm{DD}}=5 \mathrm{~V} \pm 5 \%, \mathrm{AGND}=\mathrm{DGND}=0 \mathrm{~V}, \mathrm{~V}_{\text {REF }}=$ External; all specifications $\mathrm{T}_{\text {MIN }}$ to $\mathrm{T}_{\mathrm{MAX}}$ and valid for $\mathrm{V}_{\mathrm{DRIVE}}=2.7 \mathrm{~V}$ to 5.25 V , unless otherwise noted.

All timing specifications given in Table 2 are with a 25 pF load capacitance. With a load capacitance greater than this value, a digital buffer or latch must be used.

Table 2.

| Parameter | Symbol | Min | Typ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: |
| DATA READ <br> Conversion Time <br> Quiet Time before Conversion Start CONVST Pulse Width $\overline{\text { CONVST }}$ Falling Edge to $\overline{\text { BUSY }}$ Falling Edge $\overline{\mathrm{CS}}$ Falling Edge to $\overline{\mathrm{RD}}$ Falling Edge Data Access Time $\overline{\text { CONVST }}$ Falling Edge to New Data Valid $\overline{\text { BUSY }}$ Rising Edge to New Data Valid Bus Relinquish Time $\overline{\mathrm{RD}}$ Rising Edge to $\overline{\mathrm{CS}}$ Rising Edge $\overline{\mathrm{CS}}$ Pulse Width $\overline{\mathrm{RD}}$ Pulse Width | tconv <br> tquiet <br> $\mathrm{t}_{1}$ <br> $\mathrm{t}_{2}$ <br> $t_{3}$ <br> $\mathrm{t}_{4}$ <br> $\mathrm{t}_{5}$ <br> $t_{6}$ <br> $\mathrm{t}_{7}$ <br> $\mathrm{t}_{8}$ <br> $\mathrm{t}_{14}$ <br> $\mathrm{t}_{15}$ | $\begin{aligned} & 100 \\ & 5 \end{aligned}$ <br> 0 <br> 0 <br> 30 <br> 30 | 10 | $\begin{aligned} & 300 \\ & 100 \\ & 20 \\ & 25 \\ & 30 \\ & 5 \end{aligned}$ | $\begin{aligned} & \text { ns } \\ & \text { ns } \\ & \text { ns } \\ & \text { ns } \\ & \mathrm{ns} \\ & \mathrm{~ns} \\ & \mathrm{~ns} \\ & \mathrm{~ns} \\ & \mathrm{~ns} \\ & \mathrm{~ns} \\ & \mathrm{~ns} \end{aligned}$ ns |
| DATA WRITE <br> WRITE Pulse Width <br> Data Setup Time <br> Data Hold Time $\overline{\mathrm{CS}}$ Falling Edge to WRITE Falling Edge WRITE Falling Edge to $\overline{C S}$ Rising Edge | $\begin{aligned} & \mathrm{t}_{9} \\ & \mathrm{t}_{10} \\ & \mathrm{t}_{11} \\ & \mathrm{t}_{12} \\ & \mathrm{t}_{13} \end{aligned}$ | $\begin{aligned} & 2 \\ & 6 \\ & 5 \end{aligned}$ |  |  |  |

## AD7484

## ABSOLUTE MAXIMUM RATINGS

$\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$, unless otherwise noted.

Table 3.

| Parameter | Rating |
| :---: | :---: |
| $V_{\text {DD }}$ to GND | -0.3 V to +7 V |
| V drive to GND | -0.3 V to +7 V |
| Analog Input Voltage to GND | -0.3 V to $\mathrm{AV} \mathrm{V}_{\mathrm{DD}}+0.3 \mathrm{~V}$ |
| Digital Input Voltage to GND | $\begin{aligned} & -0.3 \mathrm{~V} \text { to } \mathrm{V}_{\text {dive }}+0.3 \\ & \mathrm{~V} \end{aligned}$ |
| REFIN to GND | -0.3 V to $\mathrm{AV}_{\mathrm{DD}}+0.3 \mathrm{~V}$ |
| Input Current to Any Pin except Supplies | $\pm 10 \mathrm{~mA}$ |
| Operating Temperature Range Commercial | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |
| Storage Temperature Range | $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ |
| Junction Temperature | $150^{\circ} \mathrm{C}$ |
| $\theta_{\mathrm{JA}}$ Thermal Impedance | $50^{\circ} \mathrm{C} / \mathrm{W}$ |
| $\theta_{\text {נc }}$ Thermal Impedance | $10^{\circ} \mathrm{C} / \mathrm{W}$ |
| Lead Temperature, Soldering |  |
| Vapor Phase (60 sec) | $215^{\circ} \mathrm{C}$ |
| Infrared (15 sec) | $220^{\circ} \mathrm{C}$ |
| ESD | 1 kV |

Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only; functional operation of the device at these or any other conditions above those listed in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

## ESD CAUTION

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 V readily accumulate on the human body and test equipment and can discharge without detection. Although this product features proprietary ESD protection circuitry, permanent damage may occur on devices subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid performance degradation or loss of functionality.

## PIN CONFIGURATION AND FUNCTION DESCRIPTIONS



## AD7484

Table 4. Pin Function Descriptions

| Pin No. | Mnemonic | Description |
| :---: | :---: | :---: |
| 1, 5, 13, 46 | AV ${ }_{\text {do }}$ | Positive Power Supply for Analog Circuitry. |
| 2 | C BiAs | Decoupling Pin for Internal Bias Voltage. A 1 nF capacitor should be placed between this pin and AGND. |
| $\begin{aligned} & 3,4,6,11,12 \\ & 14,15,47,48 \end{aligned}$ | AGND | Power Supply Ground for Analog Circuitry. |
| 7 | VIN | Analog Input. Single-ended analog input channel. |
| 8 | REFOUT | Reference Output. REFOUT connects to the output of the internal 2.5 V reference buffer. A 470 nF capacitor must be placed between this pin and AGND. |
| 9 | REFIN | Reference Input. A 470 nF capacitor must be placed between this pin and AGND. When using an external voltage reference source, the reference voltage should be applied to this pin. |
| 10 | REFSEL | Reference Decoupling Pin. When using the internal reference, a 1 nF capacitor must be connected from this pin to AGND. When using an external reference source, this pin should be connected directly to AGND. |
| 16 | STBY | Standby Logic Input. When this pin is logic high, the device will be placed in standby mode. See the Power Saving section for further details. |
| 17 | NAP | NAP Logic Input. When this pin is logic high, the device will be placed in a very low power mode. See the Power Saving section for further details. |
| 18 | $\overline{C S}$ | Chip Select Logic Input. This pin is used in conjunction with $\overline{\mathrm{RD}}$ to access the conversion result. The data bus is brought out of three-state and the current contents of the output register driven onto the data lines following the falling edge of both $\overline{\mathrm{CS}}$ and $\overline{\mathrm{RD}} . \overline{\mathrm{CS}}$ is also used in conjunction with WRITE to perform a write to the offset register. $\overline{\mathrm{CS}}$ can be hardwired permanently low. |
| 19 | $\overline{\mathrm{RD}}$ | Read Logic Input. Used in conjunction with $\overline{C S}$ to access the conversion result. |
| 20 | WRITE | Write Logic Input. Used in conjunction with $\overline{C S}$ to write data to the offset register. When the desired offset word has been placed on the data bus, the WRITE line should be pulsed high. It is the falling edge of this pulse that latches the word into the offset register. |
| 21 | $\overline{\text { BUSY }}$ | Busy Logic Output. This pin indicates the status of the conversion process. The $\overline{\mathrm{BUSY}}$ signal goes low after the falling edge of CONVST and stays low for the duration of the conversion. In Parallel Mode 1, the $\overline{\mathrm{BUSY}}$ signal returns high when the conversion result has been latched into the output register. In Parallel Mode 2, the $\overline{B U S Y}$ signal returns high as soon as the conversion has been completed, but the conversion result does not get latched into the output register until the falling edge of the next CONVST pulse. |
| 22 to 28, <br> 33 to 39 | D0 to D13 | Data I/O Bits (D13 is MSB). These are three-state pins that are controlled by $\overline{\mathrm{CS}}, \overline{\mathrm{RD}}$, and WRITE. The operating voltage level for these pins is determined by the $\mathrm{V}_{\text {DRIVE }}$ input. |
| 29 | DV ${ }_{\text {D }}$ | Positive Power Supply for Digital Circuitry. |
| 30,31 | DGND | Ground Reference for Digital Circuitry. |
| 32 | V drive | Logic Power Supply Input. The voltage supplied at this pin will determine at what voltage the interface logic of the device will operate. |
| 40 | D14 | Data Output Bit for Overranging. If the overrange feature is not used, this pin should be pulled to DGND via a $100 \mathrm{k} \Omega$ resistor. |
| 41 | CONVST | Convert Start Logic Input. A conversion is initiated on the falling edge of the $\overline{\text { CONVST }}$ signal. The input track-and-hold amplifier goes from track mode to hold mode and the conversion process commences. |
| 42 | $\overline{\text { RESET }}$ | Reset Logic Input. An active low reset pulse must be applied to this pin after power-up to ensure correct operation. A falling edge on this pin resets the internal state machine and terminates a conversion that may be in progress. The contents of the offset register will also be cleared on this edge. Holding this pin low keeps the part in a reset state. |
| 43 | MODE2 | Operating Mode Logic Input. See Table 7 for details. |
| 44 | MODE1 | Operating Mode Logic Input. See Table 7 for details. |
| 45 | CLIP | Logic Input. A logic high on this pin enables output clipping. In this mode, any input voltage that is greater than positive full scale or less than negative full scale will be clipped to all 1 s or all 0 s , respectively. Further details are given in the Offset/Overrange section. |

## TERMINOLOGY

## Integral Nonlinearity

This is the maximum deviation from a straight line passing through the endpoints of the ADC transfer function. The endpoints of the transfer function are zero scale, a point $1 / 2$ LSB below the first code transition, and full scale, a point 1/2 LSB above the last code transition.

## Differential Nonlinearity

This is the difference between the measured and ideal 1 LSB change between any two adjacent codes in the ADC.

## Offset Error

This is the deviation of the first code transition $(00 \ldots 000)$ to ( $00 . . .001$ ) from the ideal, i.e., AGND + 0.5 LSB.

## Gain Error

This is the deviation of the last code transition $(111 \ldots 110)$ to (111...111) from the ideal, i.e., $V_{\text {ref }}-1.5$ LSB, after the offset error has been adjusted out.

## Track-and-Hold Acquisition Time

It is the time required for the output of the track-and-hold amplifier to reach its final value, within $\pm 1 / 2$ LSB, after the end of conversion (the point at which the track-and-hold returns to track mode).

## Signal-to-(Noise + Distortion) Ratio

This is the measured ratio of signal-to-(noise + distortion) at the output of the ADC. The signal is the rms amplitude of the fundamental. Noise is the sum of all nonfundamental signals up to half the sampling frequency ( $\mathrm{f}_{\mathrm{s}} / 2$ ), excluding dc. The ratio is dependent on the number of quantization levels in the digitization process; the more levels, the smaller the quantization noise. The theoretical signal-to-(noise + distortion) ratio for an ideal N -bit converter with a sine wave input is given by

$$
\text { Signal }- \text { to }-(\text { Noise }+ \text { Distortion })=(6.02 N+1.76) \mathrm{dB}
$$

Thus, for a 14-bit converter, this is 86.04 dB .

## Total Harmonic Distortion (THD)

THD is the ratio of the rms sum of the harmonics to the fundamental. For the AD7484, it is defined as

$$
T H D(d B)=20 \log \frac{\sqrt{V_{2}^{2}+V_{3}^{2}+V_{4}^{2}+V_{5}^{2}+V_{6}^{2}}}{V_{1}}
$$

where $V_{1}$ is the rms amplitude of the fundamental and $V_{2}, V_{3}$, $V_{4}, V_{5}$, and $V_{6}$ are the rms amplitudes of the second through the sixth harmonics.

## Peak Harmonic or Spurious Noise

Peak harmonic or spurious noise is defined as the ratio of the rms value of the next largest component in the ADC output spectrum (up to $\mathrm{f}_{\mathrm{s}} / 2$ and excluding dc ) to the rms value of the fundamental. Normally, the value of this specification is determined by the largest harmonic in the spectrum, but for ADCs where the harmonics are buried in the noise floor, it will be a noise peak.

## Intermodulation Distortion

With inputs consisting of sine waves at two frequencies, fa and fb , any active device with nonlinearities will create distortion products at sum and difference frequencies of $\mathrm{mfa} \pm \mathrm{nfb}$, where m and $\mathrm{n}=0,1,2,3$, and so on. Intermodulation distortion terms are those for which neither $m$ nor $n$ are equal to zero. For example, the second-order terms include ( $\mathrm{fa}+\mathrm{fb}$ ) and ( $\mathrm{fa}-\mathrm{fb}$ ), while the third-order terms include $(2 \mathrm{fa}+\mathrm{fb}),(2 \mathrm{fa}-\mathrm{fb}),(\mathrm{fa}+$ 2 fb ), and (fa -2 fb ).

The AD7484 is tested using the CCIF standard where two input frequencies near the top end of the input bandwidth are used. In this case, the second-order terms are usually distanced in frequency from the original sine waves, while the third-order terms are usually at a frequency close to the input frequencies. As a result, the second-order and third-order terms are specified separately. The calculation of the intermodulation distortion is as per the THD specification, where it is the ratio of the rms sum of the individual distortion products to the rms amplitude of the sum of the fundamentals expressed in dBs.

## TYPICAL PERFORMANCE CHARACTERISTICS



Figure 3. 64k FFT Plot With 10 kHz Input Tone


Figure 4. 64k FFT Plot With 1 MHz Input Tone


Figure 5. Typical DNL


Figure 6. Typical INL


Figure 7. SINAD vs. Input Tone (AD8021 Input Circuit)


Figure 8. THD vs. Input Tone for Different Input Resistances


Figure 9. PSRR Without Decoupling


Figure 10. Reference Error


Figure 11. Analog Input Circuit Used for 10 kHz Input Tone


Figure 12. Analog Input Circuit Used for 1 MHz Input Tone
Figure 11 shows the analog input circuit used to obtain the data for the FFT plot shown in Figure 3. The circuit uses the Analog Devices AD829 op amp as the input buffer. A bipolar analog signal is applied as shown and biased up with a stable, low noise dc voltage connected to the labeled terminal shown. A 220 pF compensation capacitor is connected between Pin 5 of the AD829 and the analog ground plane. The AD829 is supplied with +12 V and -12 V supplies. The supply pins are decoupled as close to the device as possible, with both a $0.1 \mu \mathrm{~F}$ and $10 \mu \mathrm{~F}$ capacitor connected to each pin. In each case, the $0.1 \mu \mathrm{~F}$ capacitor should be the closer of the two caps to the device. More information on the AD829 is available at: www.analog.com.

For higher input bandwidth applications, the Analog Devices AD8021 op amp (also available as a dual AD8022 op amp) is the recommended choice to drive the AD7484. Figure 12 shows the analog input circuit used to obtain the data for the FFT plot shown in Figure 4. A bipolar analog signal is applied to the terminal shown and biased up with a stable, low noise dc voltage connected as shown. A 10 pF compensation capacitor is connected between Pin 5 of the AD8021 and the negative supply. As with the previous circuit, the AD8021 is supplied with +12 V and -12 V supplies. The supply pins are decoupled as close to the device as possible, with both a $0.1 \mu \mathrm{~F}$ and $10 \mu \mathrm{~F}$ capacitor connected to each pin. In each case, the $0.1 \mu \mathrm{~F}$ capacitor should be the closer of the two caps to the device. The AD8021 logic reference pin is tied to analog ground, and the $\overline{\text { DISABLE }}$ pin is tied to the positive supply as shown. Detailed information on the AD8021 is available at: www.analog.com.

## CIRCUIT DESCRIPTION Converter Operation

The AD7484 is a 14 -bit algorithmic successive approximation analog-to-digital converter based around a capacitive DAC. It provides the user with track-and-hold, reference, an ADC, and versatile interface logic functions on a single chip. The normal analog input signal range that the AD7484 can convert is 0 V to 2.5 V . By using the offset and overrange features on the ADC, the AD7484 can convert analog input signals from -200 mV to +2.7 V while operating from a single 5 V supply. The part requires a 2.5 V reference, which can be provided from the part's own internal reference or an external reference source. Figure 13 shows a simplified schematic of the ADC. The control logic, SAR, and capacitive DAC are used to add and subtract fixed amounts of charge from the sampling capacitor to bring the comparator back to a balanced condition.


Figure 13. Simplified Block Diagram of AD7484
Conversion is initiated on the AD7484 by pulsing the $\overline{\text { CONVST }}$ input. On the falling edge of $\overline{\mathrm{CONVST}}$, the track-and-hold goes from track mode to hold mode and the conversion sequence is started. Conversion time for the part is 300 ns . Figure 14 shows the ADC during conversion. When conversion starts, SW2 will open and SW1 will move to Position B, causing the comparator to become unbalanced. The ADC then runs through its successive approximation routine and brings the comparator back into a balanced condition. When the comparator is rebalanced, the conversion result is available in the SAR Register.


Figure 14. ADC Conversion Phase

At the end of conversion, the track-and-hold returns to track mode and the acquisition time begins. The track-and-hold acquisition time is 70 ns . Figure 15 shows the ADC during its acquisition phase. SW2 is closed and SW1 is in Position A. The comparator is held in a balanced condition and the sampling capacitor acquires the signal on $\mathrm{V}_{\text {IN }}$.


Figure 15. ADC Acquisition Phase

## ADC TRANSFER FUNCTION

The output coding of the AD7484 is straight binary. The designed code transitions occur midway between the successive integer LSB values , i.e., $1 / 2$ LSB, $3 / 2$ LSB. The LSB size is $\mathrm{V}_{\text {Ref }} / 16384$. The nominal transfer characteristic for the AD7484 is shown in Figure 16. This transfer characteristic may be shifted as detailed in the Offset/Overrange section.


Figure 16. AD7484 Transfer Characteristic

## POWER SAVING

The AD7484 uses advanced design techniques to achieve very low power dissipation at high throughput rates. In addition to this, the AD7484 features two power saving modes, NAP and Standby. These modes are selected by bringing either the NAP or STBY pin to a logic high, respectively.

When operating the AD7484 in normal fully powered mode, the current consumption is 18 mA during conversion and the quiescent current is 12 mA . Operating at a throughput rate of 1 MSPS, the conversion time of 300 ns contributes 27 mW to the overall power dissipation.

$$
(300 \mathrm{~ns} / 1 \mu \mathrm{~s}) \times(5 \mathrm{~V} \times 18 \mathrm{~mA})=27 \mathrm{~mW}
$$

For the remaining 700 ns of the cycle, the AD7484 dissipates 42 mW of power.

$$
(700 \mathrm{~ns} / 1 \mu \mathrm{~s}) \times(5 \mathrm{~V} \times 12 \mathrm{~mA})=42 \mathrm{~mW}
$$

Therefore, the power dissipated during each cycle is
$27 \mathrm{~mW}+42 \mathrm{~mW}=69 \mathrm{~mW}$
Figure 17 shows the AD7484 conversion sequence operating in normal mode.


Figure 17. Normal Mode Power Dissipation
In NAP mode, almost all of the internal circuitry is powered down. In this mode, the power dissipation of the AD7484 is reduced to 2.5 mW . When exiting NAP mode, a minimum of 300 ns when using an external reference must be waited before initiating a conversion. This is necessary to allow the internal circuitry to settle after power-up and for the track-and-hold to properly acquire the analog input signal. The internal reference cannot be used in conjunction with the NAP mode.

If the AD7484 is put into NAP mode after each conversion, the average power dissipation will be reduced, but the throughput rate will be limited by the power-up time. Using the AD7484 with a throughput rate of 500 kSPS while placing the part in NAP mode after each conversion would result in average power dissipation as follows.

The power-up phase contributes

$$
(300 \mathrm{~ns} / 2 \mu s) \times(5 \mathrm{~V} \times 12 \mathrm{~mA})=9 \mathrm{~mW}
$$

The conversion phase contributes

$$
(300 \mathrm{~ns} / 2 \mu \mathrm{~s}) \times(5 \mathrm{~V} \times 18 \mathrm{~mA})=13.5 \mathrm{~mW}
$$

While in NAP mode for the rest of the cycle, the AD7484 dissipates only 1.75 mW of power.

$$
(1400 \mathrm{~ns} / 2 \mu \mathrm{~s}) \times(5 \mathrm{~V} \times 0.5 \mathrm{~mA})=1.75 \mathrm{~mW}
$$

Thus, the power dissipated during each cycle is

$$
9 \mathrm{~mW}+13.5 \mathrm{~mW}+1.75 \mathrm{~mW}=24.25 \mathrm{~mW}
$$

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Figure 18 shows the AD7484 conversion sequence if the part was put into NAP mode after each conversion.


Figure 18. NAP Mode Power Dissipation
Figure 19 and Figure 20 show a typical graphical representation of power versus throughput for the AD7484 when in normal and NAP modes, respectively.


Figure 19. Normal Mode, Power vs. Throughput


Figure 20. NAP Mode, Power vs. Throughput
In standby mode, all internal circuitry is powered down and the power consumption of the AD7484 is reduced to $10 \mu \mathrm{~W}$. The power-up time necessary before a conversion can be initiated is longer because more of the internal circuitry has been powered down. In using the internal reference of the AD7484, the ADC must be brought out of standby mode 500 ms before a
conversion is initiated. Initiating a conversion before the required power-up time has elapsed will result in incorrect conversion data. If an external reference source is used and kept powered up while the AD7484 is in standby mode, the power-up time required will be reduced to $80 \mu$ s.

## OFFSET/OVERRANGE

The AD7484 provides a $\pm 8 \%$ overrange capability as well as a programmable offset register. The overrange capability is achieved by the use of a 15th bit (D14) and the CLIP input. If the CLIP input is at logic high and the contents of the offset register are 0 , then the AD7484 operates as a normal 14-bit ADC . If the input voltage is greater than the full-scale voltage, the data output from the ADC are all 1s. Similarly, if the input voltage is lower than the zero-scale voltage, the data output from the ADC are all 0 s . In this case, D 14 acts as an overrange indicator. It is set to 1 if the analog input voltage is outside the nominal 0 V to 2.5 V range.

The default contents of the offset register are 0 . If the offset register contains any value other than 0 , the contents of the register are added to the SAR result at the end of conversion. This has the effect of shifting the transfer function of the ADC as shown in Figure 21 and Figure 22. However, it should be noted that with the CLIP input set to logic high, the maximum and minimum codes that the AD7484 outputs are $0 \times 3$ FFF and 0x0000, respectively. Further details are given in Table 5 and Table 6.

Figure 21 shows the effect of writing a positive value to the offset register. If, for example, the contents of the offset register contained the value 1024, then the value of the analog input voltage for which the ADC transitions from reading all 0 s to $000 \ldots 001$ (the bottom reference point) is

$$
0.5 L S B-(1024 L S B)=-156.326 \mathrm{mV}
$$

The analog input voltage for which the ADC reads full-scale ( 0 x 3 FFF ) in this example is


Figure 21. Transfer Characteristic with Positive Offset

The effect of writing a negative value to the offset register is shown in Figure 22 If a value of -512 was written to the offset register, the bottom end reference point now occurs at

$$
0.5 L S B-(-512 L S B)=78.20 \mathrm{~mW}
$$

Following this, the analog input voltage needed to produce a full-scale ( $0 \times 3 \mathrm{FFF}$ ) result from the ADC is now
$2.5 \mathrm{~V}-1.5 \mathrm{LSB}-(-512 \mathrm{LSB})=2.5779 \mathrm{~V}$
Figure 22. Transfer Characteristic with Negative Offset
Table 5 shows the expected ADC result for a given analog input voltage with different offset values and with CLIP tied to logic high. The combined advantages of the offset and overrange features of the AD7484 are shown clearly in Table 6. It shows the same range of analog input and offset values, as shown in Table 5 but with the clipping feature disabled.
Table 5. Clipping Enabled (CLIP =1)

| Offset VIN | -512 | 0 | +1024 | D14 |
| :---: | :---: | :---: | :---: | :---: |
|  | ADC DATA, D[0:13] |  |  |  |
| -200 mV | 0 | 0 | 0 | 111 |
| -156.3 mV | 0 | 0 | 0 | 110 |
| 0 V | 0 | 0 | 1024 | 100 |
| +78.2 mV | 0 | 512 | 1536 | 000 |
| +2.3435 V | 14846 | 15358 | 16383 | 000 |
| +2.5 V | 15871 | 16383 | 16383 | 001 |
| +2.5779 V | 16383 | 16383 | 16383 | 011 |
| +2.7 V | 16383 | 16383 | 16383 | 111 |

Table 6. Clipping Disabled (CLIP = 0)

| Offset VIN | $\mathbf{- 5 1 2}$ | $\mathbf{0}$ | $\mathbf{+ 1 0 2 4}$ |
| :--- | :--- | :--- | :--- |
|  | ADC DATA, D[0:13] |  |  |
| -200 mV | -1823 | -1311 | -287 |
| -156.3 mV | -1536 | -1024 | 0 |
| 0 V | -512 | 0 | 1024 |
| +78.2 mV | 0 | 512 | 1536 |
| +2.3435 V | 14846 | 15358 | 16382 |
| +2.5 V | 15872 | 16384 | 17408 |
| +2.5779 V | 16383 | 16895 | 17919 |
| +2.7 V | 17183 | 17695 | 18719 |

Values from -1310 to +1310 may be written to the offset register. These values correspond to an offset of $\pm 200 \mathrm{mV}$. A write to the offset register is performed by writing a 13-bit word to the part, as detailed in the Parallel Interface section. The 12 LSBs of the 15 -bit word contain the offset value, while the 3 MSBs must be set to 0 . Failure to write 0 s to the 3 MSBs may result in incorrect operation of the device.

## PARALLEL INTERFACE

The AD7484 features two parallel interfacing modes. These modes are selected by the mode pins (see Table 7).
Table 7. Table III. Operating Modes

|  | MODE2 | MODE1 |
| :--- | :--- | :--- |
| Do Not Use | 0 | 0 |
| Parallel Mode 1 | 0 | 1 |
| Parallel Mode 2 | 1 | 0 |
| Do Not Use | 1 | 1 |

In Parallel Mode 1, the data in the output register is updated on the rising edge of $\overline{\mathrm{BUSY}}$ at the end of a conversion and is available for reading almost immediately afterwards. Using this mode, throughput rates of up to 2.5 MSPS can be achieved. This mode should be used if the conversion data is required immediately after the conversion has completed. An example where this may be of use is if the AD7484 is operating at much lower throughput rates with the NAP mode (for power-saving reasons), and the input signal is being compared with set limits within the DSP or other controller. If the limits are exceeded, the ADC is brought immediately into full power operation and commences sampling at full speed. Figure 31 shows a timing diagram for the AD7484 operating in Parallel Mode 1 with both $\overline{\mathrm{CS}}$ and $\overline{\mathrm{RD}}$ tied low.

In Parallel Mode 2, the data in the output register is not updated until the next falling edge of $\overline{\text { CONVST. This mode could be }}$ used where a single sample delay is not vital to the system operation and conversion speeds of greater than 2.5 MSPS are desired. This may occur, for example, in a system where a large amount of samples are taken at high speed before a Fast Fourier Transform is performed for frequency analysis of the input signal. Figure 32 shows a timing diagram for the AD7484 operating in Parallel Mode 2 with both $\overline{\mathrm{CS}}$ and $\overline{\mathrm{RD}}$ tied low.

Data must not be read from the AD7484 while a conversion is taking place. For this reason, if operating the AD7484 at throughput speeds greater than 2.5 MSPS , it will be necessary to tie both the $\overline{\mathrm{CS}}$ and $\overline{\mathrm{RD}}$ pins on the AD7484 low and use a buffer on the data lines. This situation may also arise in the case where a read operation cannot be completed in the time after the end of one conversion and the start of the quiet period before the next conversion.

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The maximum slew rate at the input of the ADC should be limited to $500 \mathrm{~V} / \mu \mathrm{S}$ while $\overline{\mathrm{BUSY}}$ is low to avoid corrupting the ongoing conversion. In any multiplexed application where the channel is switched during conversion, this should happen as early as possible after the BUSY falling edge.

## Reading Data from the AD7484

Data is read from the part via a 15-bit parallel data bus with the standard $\overline{\mathrm{CS}}$ and $\overline{\mathrm{RD}}$ signals. The $\overline{\mathrm{CS}}$ and $\overline{\mathrm{RD}}$ signals are internally gated to enable the conversion result onto the data bus. The data lines D0 to D14 leave their high impedance state when both $\overline{\mathrm{CS}}$ and $\overline{\mathrm{RD}}$ are logic low. Therefore, $\overline{\mathrm{CS}}$ may be permanently tied logic low if required, and the $\overline{\mathrm{RD}}$ signal used to access the conversion result. Figure 29 shows a timing specification called $t_{\text {Quier. }}$. This is the amount of time that should be left after any data bus activity before the next conversion is initiated.

## Writing to the AD7484

The AD7484 features a user-accessible offset register. This allows the bottom of the transfer function to be shifted by $\pm 200 \mathrm{mV}$. This feature is explained in more detail in the Offset/Overrange section.

To write to the offset register, a 15-bit word is written to the AD7484 with the 12 LSBs containing the offset value in twos complement format. The 3 MSBs must be set to 0 . The offset value must be within the range -1310 to +1310 , corresponding to an offset from -200 mV to +200 mV . The value written to the offset register is stored and used until power is removed from the device, or the device is reset. The value stored may be updated at any time between conversions by another write to the device. Table 8 shows some examples of offset register values and their effective offset voltage. Figure 30 shows a timing diagram for writing to the AD7484.

Table 8. Offset Register Examples

| Code <br> (Dec) | D14 to <br> D12 | D11 to D0 (Twos <br> Complement) | Offset <br> (mV) |
| :--- | :--- | :--- | :--- |
| -1310 | 000 | 101011100010 | -200 |
| -512 | 000 | 111000000000 | -78.12 |
| +256 | 000 | 000100000000 | +39.06 |
| +1310 | 000 | 010100011110 | +200 |

## Driving the $\overline{\text { CONVST }}$ Pin

To achieve the specified performance from the AD7484, the $\overline{\text { CONVST }}$ pin must be driven from a low-jitter source. Since the falling edge on the $\overline{\text { CONVST }}$ pin determines the sampling instant, any jitter that may exist on this edge will appear as noise when the analog input signal contains high frequency components. The relationship between the analog input frequency $\left(f_{I N}\right)$, timing jitter $\left(t_{j}\right)$, and resulting SNR is given by the equation

$$
\operatorname{SNR}_{I I T T E R}(d B)=10 \log \frac{1}{\left(2 \pi \times f_{I N} \times t_{j}\right)^{2}}
$$

As an example, if the desired SNR due to jitter was 100 dB with a maximum full-scale analog input frequency of 1.5 MHz , ignoring all other noise sources, the result is an allowable jitter on the $\overline{\mathrm{CONVST}}$ falling edge of 1.06 ps . For a 14-bit converter (ideal SNR $=86.04 \mathrm{~dB}$ ), the allowable jitter will be greater than the figure given above, but due consideration must be given to the design of the $\overline{\text { CONVST }}$ circuitry to achieve 14-bit performance with large analog input frequencies.

## Typical Connection

Figure 23 shows a typical connection diagram for the AD7484 operating in Parallel Mode 1. Conversion is initiated by a falling edge on CONVST. Once $\overline{\text { CONVST }}$ goes low, the $\overline{\mathrm{BUSY}}$ signal goes low, and at the end of conversion, the rising edge of $\overline{\mathrm{BUSY}}$ is used to activate an interrupt service routine. The $\overline{\mathrm{CS}}$ and $\overline{\mathrm{RD}}$ lines are then activated to read the 14 data bits ( 15 bits if using the overrange feature).

In Figure 23, the $V_{\text {DRIVE }}$ pin is tied to $\mathrm{DV}_{\mathrm{DD}}$, which results in logic output levels being either 0 V or $\mathrm{DV}_{\mathrm{DD}}$. The voltage applied to $V_{\text {DRIVE }}$ controls the voltage value of the output logic signals. For example, if $D V_{D D}$ is supplied by a 5 V supply and $V_{\text {DRIVE }}$ by a 3 V supply, the logic output levels would be either 0 V or 3 V . This feature allows the AD7484 to interface to 3 V devices while still enabling the ADC to process signals at a 5 V supply.


Figure 23. Typical Connection Diagram

## Board Layout and Grounding

To obtain optimum performance from the AD7484, it is recommended that a printed circuit board with a minimum of three layers be used. One of these layers, preferably the middle layer, should be as complete a ground plane as possible to give the best shielding. The board should be designed in such a way that the analog and digital circuitry is separated and confined to certain areas of the board. This practice, along with avoiding running digital and analog lines close together, should help to avoid coupling digital noise onto analog lines.

The power supply lines to the AD7484 should be approximately 3 mm wide to provide low impedance paths and reduce the effects of glitches on the power supply lines. It is vital that good decoupling is also present. A combination of ferrites and decoupling capacitors should be used, as shown in Figure 23.

The decoupling capacitors should be as close to the supply pins as possible. This is made easier by the use of multilayer boards.


Figure 24.


Figure 25.


Figure 26.

The signal traces from the AD7484 pins can be run on the top layer, while the decoupling capacitors and ferrites can be mounted on the bottom layer where the power traces exist. The ground plane between the top and bottom planes provide excellent shielding.

Figure 24 to Figure 28 show a sample layout of the board area immediately surrounding the AD7484. Pin 1 is the bottom left corner of the device. Figure 24 shows the top layer where the AD7484 is mounted with vias to the bottom routing layer highlighted. Figure 27 shows the bottom layer where the power routing is with the same vias highlighted. Figure 25 shows the bottom layer silkscreen where the decoupling components are soldered directly beneath the device. Figure 28 shows the silkscreen overlaid on the solder pads for the decoupling components, and Figure 26 shows the top and bottom routing layers overlaid. The black area in each figure indicates the ground plane present on the middle layer.


Figure 27.


Figure 28.
C1 to C6: $100 \mathrm{nF}, \mathrm{C} 7$ to C8: $470 \mathrm{nF}, \mathrm{C} 9: 1 \mathrm{nF}$
L1 to L4: Meggit-Sigma Chip Ferrite Beads (BMB2A0600RS2)


Figure 29. Parallel Mode READ Cycle



## OUTLINE DIMENSIONS



COMPLIANT TO JEDEC STANDARDS MS-026BBC
Figure 33. 48-Lead Plastic Quad Flatpack (LQFP) [ST-48]
Dimensions shown in millimeters

## ORDERING GUIDE

| Model | Temperature Range | Package Description | Option |
| :--- | :--- | :--- | :--- |
| AD7484BST | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | Plastic Quad Flatpack Package (LQFP) | ST-48 |
| EVAL-AD7484CB $^{1}$ |  | Evaluation Board |  |
| EVAL-CONTROL BRD2 $^{2}$ |  | Controller Board |  |

${ }^{1}$ This can be used as a standalone evaluation board or in conjunction with the EVAL-CONTROL BOARD for evaluation/demonstration purposes.
${ }^{2}$ This board is a complete unit allowing a PC to control and communicate with all Analog Devices evaluation boards ending in the CB designators.


[^0]:    One Technology Way, P.O. Box 9106, Norwood, MA 02062-9106, U.S.A. Tel: 781.329.4700 www.analog.com Fax: 781.326.8703 © 2004 Analog Devices, Inc. All rights reserved.

[^1]:    ${ }^{1}$ SNR and SINAD figures quoted include external analog input circuit noise contribution of approximately 1 dB .
    ${ }^{2}$ See Typical Performance Characteristics section for analog input circuits used.
    ${ }^{3}$ See Terminology section.
    ${ }^{4}$ Sample tested @ $25^{\circ} \mathrm{C}$ to ensure compliance.
    ${ }^{5}$ Digital input levels at GND or $V_{\text {DRIVE. }}$

